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Attorney Docket No. 450100-05584

Applicants:

Tetsujiro KONDO, Yasushi TATEHIRA, Tsuyoshi TANAKA,  
Kazutaka UCHIDA, Naohide YAMADA, Yoshinori  
WATANABE, Shinsuke ARAYA

For:

SPACE-DIVIDING APPARATUS

U.S. Serial No.:

Filed Concurrently Herewith

Corresponding International Application. No.:

PCT/JP2005/008196

International Filing Date:

April 28, 2005

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P.O. Box 1450

Alexandria, VA 22313-1450

1. Names of Conveying Parties:

Tetsujiro KONDO, Yasushi TATEHIRA, Tsuyoshi TANAKA,  
Kazutaka UCHIDA, Naohide YAMADA, Yoshinori  
WATANABE, Shinsuke ARAYA

2. Names and addresses of receiving parties:

SONY CORPORATION  
7-35 Kitashinagawa 6-chome  
Shinagawa-Ku, Tokyo 141-0001, Japan

11/579627

3. Nature of Conveyance:

Assignment

Execution Date(s):

October 25, October 26, October 26, October 26, October 26,  
October 26 and October 26, 2006.

4. ☐ Application No.:

☒ This document is being filed together with a new application, the execution date of the application is:  
October 25, October 26, October 26, October 26, October 26,  
October 26 and October 26, 2006.

5. Name and address of party to whom the recorded assignment and any correspondence concerning the document should be mailed:

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(40.00 DP)

William S. Frommer  
Registration No. 25,506  
FROMMER LAWRENCE & HAUG LLP  
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New York, New York 10151

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41):

\$40.00

☒ Fee enclosed.

8. ☐ Charge Fee Deposit Account No. 50-0320 (Attach duplicate copy of this page if paying by deposit account).

☐ If any additional fee is required, authorization is hereby given to charge Deposit Account No. 50-0320.

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William S. Frommer

Name of Person Signing

Signature

November 6, 2006

Date

00409208.DOC

PATENT  
REEL: 018530 FRAME: 0832

**ASSIGNMENT**

**WHEREAS**, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in **SPACE-DIVIDING APPARATUS** for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

**AND WHEREAS**, SONY CORPORATION, a Japanese Corporation, with offices at 7-35 Kitashinagawa 6-chome, Shinagawa-Ku, Tokyo, 141-0001, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

**NOW THEREFORE**, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: International Serial Number: PCT/JP2005/008196, International Filing Date: April 28, 2005.

This assignment executed on the dates indicated below.

**Tetsujiro KONDO**

Name of sole or 1st inventor

Execution date of U.S. Patent Application

**Tokyo, Japan**

Residence of sole or 1st inventor

*Tetsujiro Kondo**Oct. 25, 2006*

Signature of sole or 1st inventor

Date of this assignment

**Yasushi TATEHIRA**

Name of 2nd joint inventor

Execution date of U.S. Patent Application

**Kanagawa, Japan**

Residence of 2nd joint inventor

*Yasushi Tatehira**Oct. 26, 2006*

Signature of 2nd joint inventor

Date of this assignment

# ADDITIONAL INVENTORS

**Tsuyoshi TANAKA**

Name of 3rd joint inventor

Execution date of U.S. Patent Application

**Tokyo, Japan**

Residence of 3rd joint inventor

Signature of 3rd joint inventor

Date of this assignment

*Tsuyoshi Tanaka*

*Oct. 26, 2006*

**Kazutaka UCHIDA**

Name of 4th joint inventor

Execution date of U.S. Patent Application

**Tokyo, Japan**

Residence of 4th joint inventor

Signature of 4th joint inventor

Date of this assignment

*Kazutaka Uchida*

*Oct 26, 2006*

**Naohide YAMADA**

Name of 5th joint inventor

Execution date of U.S. Patent Application

**Tokyo, Japan**

Residence of 5th joint inventor

Signature of 5th joint inventor

Date of this assignment

*Naohide Yamada*

*Oct. 26, 2006*

**Yoshinori WATANABE**

Name of 6th joint inventor

Execution date of U.S. Patent Application

**Kanagawa, Japan**

Residence of 6th joint inventor

Signature of 6th joint inventor

Date of this assignment

*Yoshinori Watanabe*

*Oct. 26, 2006*

**Shinsuke ARAYA**

Name of inventor

Execution date of U.S. Patent Application

**Kanagawa, Japan**

Residence of inventor

Signature of inventor

Date of this assignment

*Shinsuke Araya*

*Oct. 26, 2006*